

INFORMATION DISCLOSURE CITATION	Docket No. POU920030111US1	Serial No. Unassigned
	Applicant: Chu et al. <i>Express Mail ERO46554791US</i>	
	Filing Date: Filed Herewith	Group: Unassigned

U.S. PATENT DOCUMENTS								
Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
<i>TM</i>	AA	5,864,466	1/26/99	Remsburg	361	700		
<i>TM</i>	AB	6034,872	3/07/00	Chrysler et al.	361	699		
	AC	6,064,572	5/16/00	Remsburg	361	700		
	AD	6,082,443	7/4/00	Yamamoto et al.	165	104.26		
	AE	6,167,948	1/2/01	Thomas	165	104.26		
	AF	6,213,194	4/10/01	Chrysler et al.	165	80.3		
	AG	6,223,810	5/1/01	Chu et al.	165	104.33		
	AH	6,269,866	8/7/01	Yamamoto et al.	165	104.26		
	AI	6,302,192	10/16/01	Dussinger et al.	165	104.26		
	AJ	6,366,462	4/2/02	Chu et al.	361	699		
<i>TM</i>	AK	6,397,618	6/4/02	Chu et al.	62	259.2		
FOREIGN PATENT DOCUMENTS								
		DOCUMENT NUMBER	Date	Country	Class	Subclass	Translation	
							Yes	No
<i>TM</i>	AL	WO 98/22767	28/5/98	PCT	F28D	15/00	X	
<i>TM</i>	AM	JP 2001-024374	26/01/01	Japan	H05K	7/20	(Abstract)	
Other Documents (including Author, Title, Date, pertinent public. etc.)								
<i>TM</i>	AN	"Two Stage Cooling System Employing Thermoelectric Modules," Chu et al., Serial No. 10/115,903, filed April 4, 2002						

Examiner <i>David M. [Signature]</i>	Date Considered <i>4-29-04</i>
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